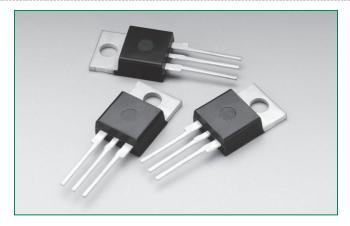


Q6008LH1LED Series

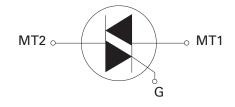


Agency Approval

Agency	Agency File Number
.91	L Package: E71639

Main Features					
Symbol	Value	Unit			
I _{T(RMS)}	8	А			
V _{DRM} /V _{RRM}	600	V			
I _{gt}	10	mA			

Schematic Symbol



Description

Q6008LH1LED series is designed to meet low load current characteristics typical in LED lighting applications.

By keeping holding current at 6mA maximum, this Triac series is characterized and specified to perform best with LED loads. The Q6008LH1LED series is best suited for LED dimming controls to obtain the lowest levels of light output with a minimum probability of flickering.

Q6008LH1LED series is offered in the industry standard TO-220AB package with an isolated mounting tab that makes it best suited for adding an external heat sink.

Features

- As low as 6mA max holding current
- UL recognized TO-220AB package
- 110°C rated junction temperature
- di/dt performance of 70A/µs
- QUADRAC version includes intergrated DIAC

Benefits

- Provides full control of light out put at the extreme low end of load conditions.
- 2500V _{AC} min isolation between mounting tab and active terminals
- Improves margin of safe operation with less heat sinking required
- Enable survivability of typically LED load operating characteristics
- Simplicity of circuit design & layout

Applications

Excellent for AC switching and phase control applications such as heating, lighting, and motor speed controls.

Typical applications are AC solid-state switches, lighting controls with LED lamp loads, small low current motor in power tools, and low current motors in home/brown goods appliances.

Internally constructed isolated packages are offered for ease of heat sinking with highest isolation voltage.



Absolute Maximum Ratings

Symbol	Parameter	Test Conditions		Value	Unit
I _{T(RMS)}	RMS on-state current (full sine wave)		$T_c = 80^{\circ}C$	8	А
1	Non repetitive surge peak on-state current (full cycle, T _J initial = 25°C)	f = 50 Hz	t = 20 ms	80	А
ITSM		(full cycle, T_J initial = 25°C) $f = 60 \text{ Hz}$	f = 60 Hz	t = 16.7 ms	85
l²t	I²t Value for fusing		t _p = 8.3 ms	30	A²s
di/dt	Critical rate of rise of on-state current	f = 120 Hz	T _J = 110°C	70	A/µs
I _{gtm}	Peak gate trigger current	t _P ≤ 10 μs; I _{GT} ≤ I _{GTM}	T _J = 110°C	1.6	A
P _{G(AV)}	Average gate power dissipation	T _J = 110°C	I _{gt} = 35mA	0.5	W
T _{stg}	Storage temperature range			-40 to 150	°C
T	Operating junction temperature range			-40 to 110	°C

Electrical Characteristics (T_J = 25°C, unless otherwise specified)

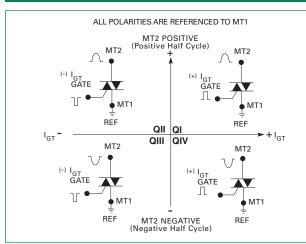
Symbol	Test Conditions	Quadrant		Value	Unit
I _{gt}	$V_{\rm p} = 12V R_{\rm i} = 60 \Omega$	- -	MAX.	10	mA
V _{GT}	$v_{\rm D} = 12V$ $R_{\rm L} = 60.22$	- -		1.3	V
V _{gd}	$V_{_{D}} = V_{_{DRM}} R_{_{L}} = 3.3 \text{ k}\Omega T_{_{J}} = 110^{\circ}\text{C}$	- -	MIN.	0.2	V
I _H	I _T = 15mA		MAX.	6	mA
dv/dt	$V_{D} = V_{DRM}$ Gate Open $T_{J} = 110^{\circ}C$		MIN.	50	V/µs
(dv/dt)c	$(di/dt)c = 4.3 \text{ A/ms } T_{J} = 110^{\circ}\text{C}$		MIN.	10	V/µs
t _{gt}	I _g = 100mA PW = 15μs I _τ = 11.3 A(pk)		TYP.	4.0	μs

Static Characteristics						
Symbol		Test Conditions		Value	Unit	
V _{TM}	I _{TN}	I _{TM} = 11.3A t _p = 380 μs		1.60	V	
I _{drm} I _{rrm}	$V_{\text{drm}} = V_{\text{rrm}}$	T _J = 110°C	MAX.	500	μΑ	

Thermal Resistances				
Symbol	Parameter	Value	Unit	
R _{θ(J-C)}	Junction to case (AC)	2.8	°C/W	
R _{θ(J-A)}	Junction to ambient	50	°C/W	

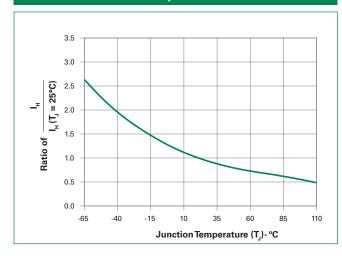


Figure 1: Definition of Quadrants



Note: Alternistors will not operate in QIV

Figure 3: Normalized DC Holding Current vs. Junction Temperature





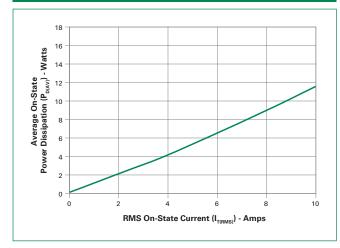


Figure 2: Normalized DC Gate Trigger Current for All Quadrants vs. Junction Temperature

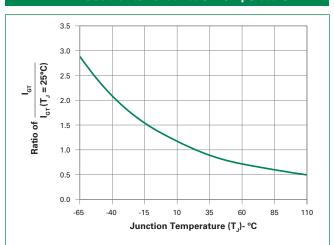


Figure 4: Normalized DC Gate Trigger Voltage for All Quadrants vs. Junction Temperature

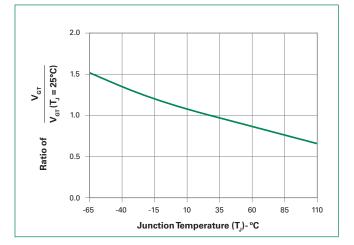
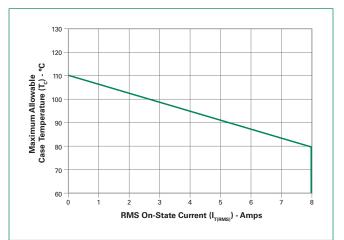


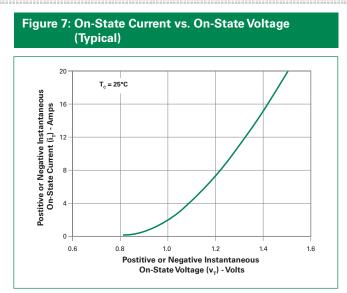
Figure 6: Maximum Allowable Case Temperature vs. On-State Current (Standard / Alternistor Triac)



Q6008LH1LED Series

3 Revised: January 25, 2013, 08:34 AM Downloaded From Oneyac.com ©2013 Littlefuse, Inc Specifications are subject to change without notice. Please refer to http://www.littlefuse.com for current information.





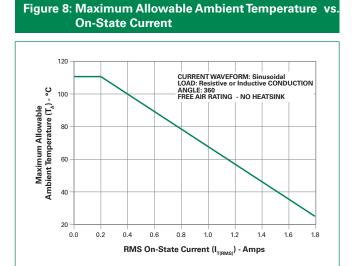
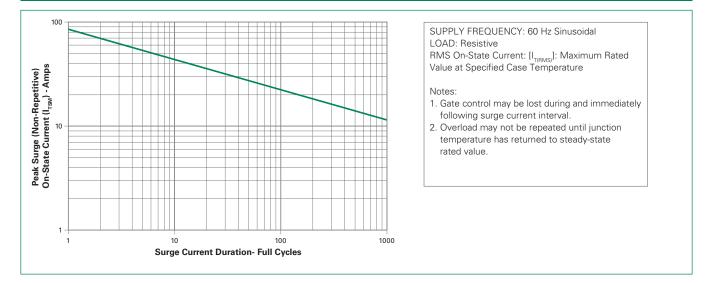


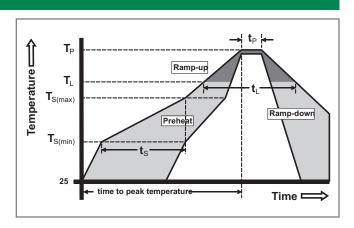
Figure 9: Surge Peak On-State Current vs. Number of Cycles





Soldering Parameters

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 secs	
Average ramp up rate (LiquidusTemp) (T _L) to peak		5°C/second max	
$T_{S(max)}$ to T_{L} - Ramp-up Rate		5°C/second max	
Deflow	-Temperature (T _L) (Liquidus)	217°C	
Reflow	-Temperature (t _L)	60 – 150 seconds	
PeakTemp	erature (T _P)	260 ^{+0/-5} °C	
Time within 5°C of actual peak Temperature (t _p)		20 – 40 seconds	
Ramp-down Rate		5°C/second max	
Time 25°C to peak Temperature (T _P)		8 minutes Max.	
Do not exc	ceed	280°C	



Physical Specifications

Terminal Finish	100% Matte Tin-plated
Body Material	UL recognized epoxy meeting flammability classification 94V-0
Terminal Material	Copper Alloy

Design Considerations

Careful selection of the correct device for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the device rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

Environmental Specifications

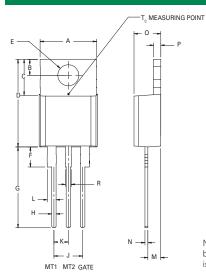
Test	Specifications and Conditions
AC Blocking (V _{DRM})	MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 110°C for 1008 hours
Temperature Cycling	MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell-time
Temperature/ Humidity	EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity
High Temp Storage	MIL-STD-750, M-1031, 1008 hours; 150°C
Low-Temp Storage	1008 hours; -40°C
Thermal Shock	MIL-STD-750, M-1056 10 cycles; 0°C to 100°C; 5-min dwell- time at each temperature; 10 sec (max) transfer time between temperature
Autoclave EIA / JEDEC, JESD22-A102 168 hours (121°C at 2 ATMs) and 100% R/H	
Resistance to Solder Heat	MIL-STD-750 Method 2031
Solderability	ANSI/J-STD-002, category 3, Test A
Lead Bend	MIL-STD-750, M-2036 Cond E

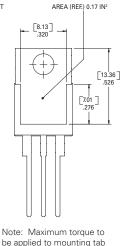
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Dimensions - TO-220AB (L-Package) - Isolated Mounting Tab

P





be applied to mounting tab is 8 in-lbs. (0.904 Nm).

Dimension	Inc	hes	Millin	neters
Dimension	Min	Max	Min	Max
А	0.380	0.420	9.65	10.67
В	0.105	0.115	2.67	2.92
С	0.230	0.250	5.84	6.35
D	0.590	0.620	14.99	15.75
E	0.142	0.147	3.61	3.73
F	0.110	0.130	2.79	3.30
G	0.540	0.575	13.72	14.61
Н	0.025	0.035	0.64	0.89
J	0.195	0.205	4.95	5.21
K	0.095	0.105	2.41	2.67
L	0.060	0.075	1.52	1.91
Μ	0.085	0.095	2.16	2.41
Ν	0.018	0.024	0.46	0.61
0	0.178	0.188	4.52	4.78
Р	0.045	0.060	1.14	1.52
R	0.038	0.048	0.97	1.22

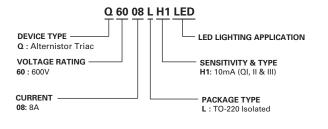
Product Selector

Part Number	Gate Sensitivity Quadrants	Tupo	Poskogo	
Fait Nulliper	I – II – III	Туре	Package	
Q6008LH1LED	10 mA	Alternistor Triac	TO-220L	

Packing Options

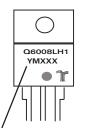
Part Number	Marking	Weight	Packing Mode	Base Quantity
Q6008LH1LED	Q6008LH1	2.2 g	Bulk	500
Q6008LH1LEDTP	Q6008LH1	2.2 g	Tube Pack	500 (50 per tube)

Part Numbering System



Part Marking System

TO-220 AB - (L Package)



Date Code Marking Y:Year Code M: Month Code XXX: Lot Trace Code

单击下面可查看定价,库存,交付和生命周期等信息

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